

Session 8, questions 5-8 Alonso D. Peralta, PhD. Staff Engineer Materials and Process Engineering Honeywell Aerospace Collaborators: HON: J. Neumann, H. Deutchman ESI: M. Megahed QuesTek: J. Gong, D. Snyder, G. Olson Sigma Labs: M. Cola SwRI: M. Enright, J. McFarland Stratonics: J. Craig

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Questions to be Addressed

- (5) What measurements of quality or systems are appropriate that correlate computational and analytical methods to practical implementation?
- (6) Software architecture and data-bases for AM model development
- (7) Careful design of validation experiments for model validation, uncertainty quantification, and in situ process monitoring
- (8) Software development, integration with precision engineering, and integration into engineering work flow

Examples of DMLS Built Components at Honeywell

Various Part Complexities were Manufactured



Functional Testing Substantiations ranging from rig to engine testing

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Examples of Software/Database Requirements



Possible Defects Found in Powder Bed Laser AM Builds



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AM 718Plus Yield Strength Comparison



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Task 2: PrintRite3D Quality Metric Analysis Results: New pyrometers: IMPAC IGA 740-LO



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5. What measurements of quality or systems are appropriate that correlate computational and analytical methods to practical implementation?

- Requirements are driven by Design Intent
- Manufacturing requirements and controls need to be commensurate with the design intent
- For the most part, the requirements for components tend to be:
 - Functional
 - Dimensional
 - \circ accuracy of the process,
 - Distortion due to the process
 - surface finish capabilities of the process, etc.
 - Service life related
 - \circ failure modes
 - material defects
 - Material microstructure / phases
 - Grain size, etc.

Computational methods must have the capability to simulate the process

- Replicate the process, follow the laser and simulate the melting and solidification
- deformation during the build, to predict dimensional qualities of the process
- surface roughness, which is a function of the build layer thickness, the powder size distribution, the randomness of the powder spreading, the laser beam diameter, the hatch spacing, the laser power, etc.





Recoating of the powder layer, 2nd Layer





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Recoating a 2nd Layer: Large particles can lead to recoater blade crashes





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hermal Animation and Residual Stress Model: Hatch and Stripe Model



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6. Software architecture and data-bases for AM model development

- Software requirements
 - Melt pool
 - Model the power size distribution
 - Model the powder spreading
 - Model the laser powder interaction
 - Model the CFD melting and solidification, heat transfer, Marangoni forces, etc.
 - Model defect generation, i.e porosity, micro cracking
 - Model the micro scale residual stresses, at the melt pool level
 - <u>Structural</u>
 - Model the macro scale residual stresses, at the structural level
 - Deformation, at the structural level
 - <u>Microstructure</u>
 - Model the material microstructure evolution, i.e. phases, grain growth, defects
 - Properties
 - > Yield, Ultimate, fatigue, crack growth, creep, environmental effects
- Location and orientation specific prediction capabilities
- Software may be self standing or integrated, but information shared



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6. Software architecture and data-bases for AM model development

Database requirements

Material properties needed for use in the Computational models

- From room temperature to boiling point
- For non equilibrium conditions
- > At very high rates

Experiments to verify the relevant physics of the process

- Laser scribing/ melting on solid
- Laser scribing/ melting on powder
- At various processing conditions
- Build simple shapes and determine deformation 1D i.e. beams
- Build more complex 2D i.e. plates
- Build components 3D i.e. airfoils,
- As build microstructure characterization
- As stress relieved microstructure
- As HIPped, as Solution, as Aged microstructures
- ≻ ...



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δ: 30μm, H: 100 μm, v: 2250 mm/s (10.5.3)





Side View



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Micro-Model Defect Prediction





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19 Examples of Software and Experimental databases for Materials Modeling



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Final Microstructure: Phase Fraction & Compositions



Final microstructure after double step aging (varying solution temperature):

Solution temperature in F

phase fraction 1775 1750 1800 1950 δ-Ni3Nb 5.93% 5.39% 4.66% f % γ'_p-Ni3(Al,Nb,Ti) 3.67% 1.60% γ'_s-Ni3(Al,Nb,Ti) 20.07% 20.85% 21.16% 22.93%

Compositions (1775F solution treatment):

Composition in at%		Ni	Cr	Fe	Со	Мо	AI	W	Nb	Ti	RMS
matrix	prediction	45.65	26.92	12.80	10.79	2.17	0.92	0.36	0.35	0.03	0.66
	LEAP*	44.30	26.40	13.20	11.50	2.10	0.40	0.40	1.30	0.10	
γ'	prediction	70.47	1.13	1.27	2.88	0.20	11.91	0.21	8.48	3.44	0.37
	LEAP*	70.69	0.65	1.27	3.39	-	11.28	-	8.85	3.19	

*L. Viskari, K. Stiller, Ultramicroscopy 111(2011) 652-658

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YS Model for 718 plus

I. Solution treated material

• Assume linear superposition of strengths of primary phases





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YS Model for 718 plus

II. Aged material

• Includes effect of secondary γ' precipitates.

In addition to grain size and solid solution strengthening, secondary γ ' precipitates' effect on dislocation motion mechanisms contributes to strength.

Strength of δ phase extracted from YS of soln. treated material at higher temp.

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r: Radius of secondary \gamma' precipitates.
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7. Careful design of validation experiments for model validation, uncertainty quantification, and *in situ* process monitoring

 Example Experiments Follow, prior examples also fit as examples or this question



Laser Power and Size Calibration



Camera based Beam Profiler is set to re-coater height Beam sampled at center and each corner of platform





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Melt Pool Shape and Temperature "Measurement"



Low Power



-2400



High Power



ThermaVis® Imaging Pyrometer Frame 34 -2600 -2400 -2200 -2000 -1600 -1600

Fast Sneed

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Pyrometer Temperature Measurements



SIGMA LABS

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Digital Camera Temperature Measurements



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δ: 20μm, H: 140 μm, v: 880 mm/s $_{(10.4.2)}$ Model / Simulation Temperature Predictions



Top: Bead Middle: Pool Bottom: Pool deep





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Build Parameters vs. Residual Stress

	_	hatch		
	Power	spacing	speed	
No	Watts	mm	mm/s	
A1	370	0.09	1000	
A2	300	0.09	1000	
A3	250	0.09	1000	
A4	200	0.09	1000	
A5	150	0.09	1000	
A6	370	0.09	1250	
A7	300	0.09	1250	
A8	250	0.09	1250	
A9	200	0.09	1250	
A10	150	0.09	1250	
A11	370	0.09	1500	
A12	300	0.09	1500	
A13	250	0.09	1500	
A14	200	0.09	1500	
A15	150	0.09	1500	
A16	370	0.13	1000	
A17	300	0.13	1000	
A18	250	0.13	1000	
A19	200	0.13	1000	
A20	150	0.13	1000	
A21	370	0.13	1250	
A22	300	0.13	1250	
A23	250	0.13	1250	
A24	200	0.13	1250	
A25	150	0.13	1250	
A26	370	0.13	1500	1
A27	300	0.13	1500	
A28	250	0.13	1500	
A29	200	0.13	1500	
A30	150	0.13	1500	

<u>Objective</u>: Understand the effect of Power, Speed, and Hatch Spacing on Residual Stress.





<u>Method</u>: Printing 90 beams with varying power, speed, and hatch spacing. Then measuring deflections using our CMM to calculate stress. $\sigma_{Max} = -E\kappa \frac{t}{2}$



0.18 0.13 0.08 0 0.5 1 1.5 2 2.5 x (in)

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Specimens are being measured

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Deformed Beam Data: Same Build Conditions



Plots confirm, an assumed constant max stress independent of thickness

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Deformed Beam Data: Different Build Conditions



Speed and Power are most important variables, not hatch spacing oneywell

 $\sigma_{true} - \varepsilon_{true}$ Curve and UTS Analysis



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Residual Stress UQ Model



X1

Fit Sysweld residual stress results to Gaussian Process (GP) response surfaces

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Used response surfaces for:

- UQ of residual stress contours (mean/stdev.)
- Sensitivity analysis at select locations



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8. Software development, integration with precision engineering, and integration into engineering work flow

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• Develop software for realm of interest

- High fidelity, physics-based simulations to simulate the process at the micro scale and understand differences between build conditions and between geometrical differences
- Computationally faster engineering simulations for component / structural simulation based on high fidelity models

Location specific material properties need to be integrated into current FE codes ICME need to be moved over to the Analysis and Manufacturing Groups, maybe a concurrent engineering philosophy is needed.

Thank You!

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